# 捷多邦,专业PCB打样工厂**SN54种024**4年SN74HC244 OCTAL BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS

SCLS130D - DECEMBER 1982 - REVISED AUGUST 2003

- Wide Operating Voltage Range of 2 V to 6 V
- High-Current Outputs Drive Up To 15 LSTTL Loads
- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers

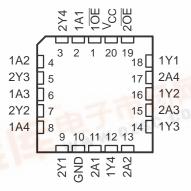
SN54HC244 . . . J OR W PACKAGE SN74HC244 . . . DB, DW, N, NS, OR PW PACKAGE (TOP VIEW)

10E	1	20	] v <sub>cc</sub>
1A1	2	19	20E
2Y4		18	] 1Y1
1A2	4	17	] 2A4
2Y3	5	16	] 1Y2
1A3	6	15	] 2A3
2Y2	7	14	] 1Y3
1A4	8	13	] 2A2
2Y1	9	12	1Y4
GND	10	11	] 2A1

Low Power Consumption, 80-μA Max I<sub>CC</sub>

- Typical t<sub>pd</sub> = 11 ns
- ±6-mA Output Drive at 5 V
- Low Input Current of 1 μA Max





# description/ordering information

PRODUCTION DATA information is current as of publication date. Froducts conform to specifications per the terms of Texas Instruments standard warganty. Production processing does not necessarily include testing of all parameters.

These octal buffers and line drivers are designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. The 'HC244 devices are organized as two 4-bit buffers/drivers with separate output-enable ( $\overline{OE}$ ) inputs. When  $\overline{OE}$  is low, the device passes noninverted data from the A inputs to the Y outputs. When  $\overline{OE}$  is high, the outputs are in the high-impedance state.

#### ORDERING INFORMATION

TA	PACKA	ge†	ORDERABLE PART NUMBER	TOP-SIDE MARKING
the Colombia	PDIP – N	Tube of 20	SN74HC244N	SN74HC244N
The way	SOIC - DW	Tube of 25	SN74HC244DW	HC244
CT 1	30IC - DW	Reel of 2000	SN74HC244DWR	HC244
–40°C to 85°C	SOP - NS	Reel of 2000	SN74HC244NSR	HC244
-40 C to 65 C	SSOP - DB	Reel of 2000	SN74HC244DBR	HC244
		Tube of 70	SN74HC244PW	E.W DISC
	TSSOP - PW	Reel of 2000	SN74HC244PWR	HC244
		Reel of 250	SN74HC244PWT	Page 4 acres
	CDIP – J	Tube of 20	SNJ54HC244J	SNJ54HC244J
–55°C to 125°C	CFP – W	Tube of 85	SNJ54HC244W	SNJ54HC244W
THE B	LCCC – FK	Tube of 55	SNJ54HC244FK	SNJ54HC244FK

Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

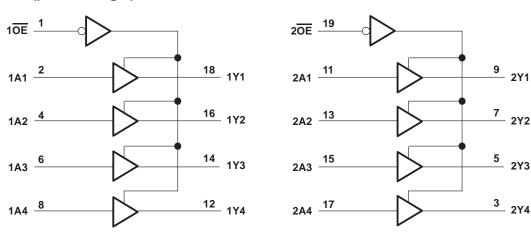


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# FUNCTION TABLE (each buffer/driver)

INP	JTS	OUTPUT
OE	Α	Υ
L	Н	Н
L	L	L
Н	Χ	Z

# logic diagram (positive logic)



# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>	
Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ ) (see Note 1)	±20 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ ) (see Note 1)	±20 mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )	
Continuous current through V <sub>CC</sub> or GND	
Package thermal impedance, θ <sub>JA</sub> (see Note 2): DB package	
DW package	58°C/W
N package	69°C/W
NS package	60°C/W
·	83°C/W
Storage temperature range, T <sub>stg</sub>	

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.



# SN54HC244, SN74HC244 **OCTAL BUFFERS AND LINE DRIVERS** WITH 3-STATE OUTPUTS SCLS130D - DECEMBER 1982 - REVISED AUGUST 2003

## recommended operating conditions (see Note 3)

			AS	154HC24	4	SN	174HC24	14	UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	UNII
Vcc	Supply voltage		2	5	6	2	5	6	V
		V <sub>CC</sub> = 2 V	1.5			1.5			
VIH	High-level input voltage	V <sub>CC</sub> = 4.5 V	3.15			3.15			V
		VCC = 6 V	4.2			4.2			
		V <sub>CC</sub> = 2 V			0.5			0.5	
$V_{IL}$	Low-level input voltage	V <sub>CC</sub> = 4.5 V			1.35			1.35	V
		V <sub>CC</sub> = 6 V			1.8			1.8	
٧ <sub>I</sub>	Input voltage		0		VCC	0		VCC	V
٧o	Output voltage		0		VCC	0		VCC	V
		V <sub>CC</sub> = 2 V			1000			1000	
Δt/Δν	Input transition rise/fall time	V <sub>CC</sub> = 4.5 V			500			500	ns
		V <sub>CC</sub> = 6 V			400			400	
T <sub>A</sub>	Operating free-air temperature		-55		125	-40		85	°C

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CO	ONDITIONS	V	Т	A = 25°C	;	SN54H	IC244	SN74H	C244	UNIT
PARAMETER	TEST CC	MUITIONS	vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
			2 V	1.9	1.998		1.9		1.9		
		I <sub>OH</sub> = -20 μA	4.5 V	4.4	4.499		4.4		4.4		
Voн	VI = VIH or VIL		6 V	5.9	5.999		5.9		5.9		V
		$I_{OH} = -6 \text{ mA}$	4.5 V	3.98	4.3		3.7		3.84		
		$I_{OH} = -7.8 \text{ mA}$	6 V	5.48	5.8		5.2		5.34		
		I <sub>OL</sub> = 20 μA	2 V		0.002	0.1		0.1		0.1	
			4.5 V		0.001	0.1		0.1		0.1	
VOL	VI = VIH or VIL		6 V		0.001	0.1		0.1		0.1	V
		$I_{OL} = 6 \text{ mA}$	4.5 V		0.17	0.26		0.4		0.33	
		$I_{OL} = 7.8 \text{ mA}$	6 V		0.15	0.26		0.4		0.33	
lį	$V_I = V_{CC}$ or 0		6 V		±0.1	±100		±1000		±1000	nA
loz	$V_O = V_{CC}$ or 0,	VI = VIH or VIL	6 V		±0.01	±0.5		±10		±5	μΑ
Icc	$V_I = V_{CC}$ or 0,	I <sub>O</sub> = 0	6 V			8		160		80	μΑ
Ci			2 V to 6 V		3	10		10		10	pF

# SN54HC244, SN74HC244 OCTAL BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS SCLS130D – DECEMBER 1982 – REVISED AUGUST 2003

# switching characteristics over recommended operating free-air temperature range, $C_L$ = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	V	T	( = 25°C	;	SN54H	C244	SN74H	IC244	UNIT
PARAMETER	(INPUT)	(OUTPUT)	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNII
			2 V		40	115		170		145	
<sup>t</sup> pd	А	Y	4.5 V		13	23		34		29	ns
·			6 V		11	20		29		25	
		Y	2 V		75	150		225		190	
t <sub>en</sub>	ŌĒ		4.5 V		15	30		45		38	ns
			6 V		13	26		38		32	
		Y	2 V		75	150		225		190	
<sup>t</sup> dis	ŌĒ		4.5 V		15	30		45		38	ns
			6 V		13	26		38		32	
		Y	2 V		28	60		90		75	ns
t <sub>t</sub>			4.5 V		8	12		18		15	
			6 V		6	10		15		13	

# switching characteristics over recommended operating free-air temperature range, $C_L$ = 150 pF (unless otherwise noted) (see Figure 1)

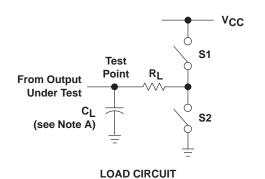
PARAMETER	FROM	то	Vaa	T,	չ = 25°C	;	SN54H	IC244	SN74H	C244	UNIT												
PARAMETER	(INPUT)	(OUTPUT)	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	ONIT												
			2 V		56	165		245		210													
<sup>t</sup> pd	t <sub>pd</sub> A	Y	4.5 V		18	33		49		42	ns												
·			6 V		15	28		42		35													
		Y	2 V		100	200		300		250	250 50 ns												
t <sub>en</sub>	ŌĒ		4.5 V		20	40		60		50													
			6 V		17	34		51		43													
		Y	2 V		45	210		315		265													
t <sub>t</sub>			Y	Y	Y	Y	Y	Y	Y	Y	Y	Y	Y	Y	4.5 V		17	42		63		53	ns
			6 V		13	36		53		45													

# operating characteristics, $T_A = 25^{\circ}C$

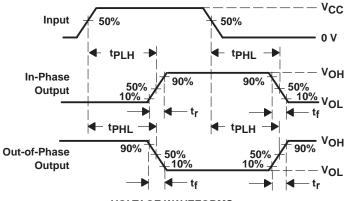
	PARAMETER	TEST CONDITIONS	TYP	UNIT
C <sub>pd</sub>	Power dissipation capacitance per buffer/driver	No load	35	pF

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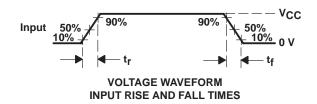
#### PARAMETER MEASUREMENT INFORMATION

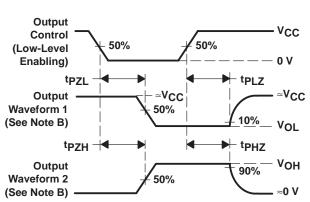


PARAI	METER	RL	CL	S1	S2	
	tPZH	<b>1 k</b> Ω	50 pF or	Open	Closed	
ten	tPZL	1 K22	150 pF	Closed	Open	
4	<sup>t</sup> PHZ	1 kΩ	50 pF	Open	Closed	
<sup>t</sup> dis	tPLZ	1 K22	30 pr	Closed	Open	
t <sub>pd</sub> or t <sub>t</sub>		_	50 pF or 150 pF	Open	Open	



VOLTAGE WAVEFORMS
PROPAGATION DELAY AND OUTPUT TRANSITION TIMES





VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES FOR 3-STATE OUTPUTS

NOTES: A. C<sub>L</sub> includes probe and test-fixture capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O = 50 \Omega$ ,  $t_r = 6$  ns,  $t_f = 6$  ns.
- D. The outputs are measured one at a time with one input transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms







26-Sep-2005

## **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp (3)
5962-8409601VRA	ACTIVE	CDIP	J	20	1	TBD	Call TI	Level-NC-NC-NC
5962-8409601VSA	ACTIVE	CFP	W	20	1	TBD	Call TI	Level-NC-NC-NC
84096012A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
8409601RA	ACTIVE	CDIP	J	20	1	TBD	Call TI	Level-NC-NC-NC
8409601SA	ACTIVE	CFP	W	20	1	TBD	Call TI	Level-NC-NC-NC
JM38510/65705B2A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
JM38510/65705BRA	ACTIVE	CDIP	J	20	1	TBD	Call TI	Level-NC-NC-NC
JM38510/65705BSA	ACTIVE	CFP	W	20	1	TBD	Call TI	Level-NC-NC-NC
SN54HC244J	ACTIVE	CDIP	J	20	1	TBD	Call TI	Level-NC-NC-NC
SN74HC244ADBLE	OBSOLETE	SSOP	DB	20		TBD	Call TI	Call TI
SN74HC244APWLE	OBSOLETE	TSSOP	PW	20		TBD	Call TI	Call TI
SN74HC244DBLE	OBSOLETE	SSOP	DB	20		TBD	Call TI	Call TI
SN74HC244DBR	ACTIVE	SSOP	DB	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC244DBRE4	ACTIVE	SSOP	DB	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC244DW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC244DWE4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
SN74HC244DWG4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
SN74HC244DWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
SN74HC244DWRE4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC244DWRG4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC244N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74HC244N3	OBSOLETE	PDIP	N	20		TBD	Call TI	Call TI
SN74HC244NE4	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74HC244NSG4	ACTIVE	SO	NS	20	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
SN74HC244NSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
SN74HC244NSRE4	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
SN74HC244NSRG4	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
SN74HC244PW	ACTIVE	TSSOP	PW	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
SN74HC244PWE4	ACTIVE	TSSOP	PW	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
SN74HC244PWLE	OBSOLETE	TSSOP	PW	20		TBD	Call TI	Call TI
SN74HC244PWR	ACTIVE	TSSOP	PW	20	2000	Green (RoHS &	CU NIPDAU	Level-1-260C-UNLIN



#### PACKAGE OPTION ADDENDUM

26-Sep-2005

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
						no Sb/Br)		
SN74HC244PWRE4	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC244PWT	ACTIVE	TSSOP	PW	20	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC244PWTE4	ACTIVE	TSSOP	PW	20	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SNJ54HC244FK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54HC244J	ACTIVE	CDIP	J	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54HC244W	ACTIVE	CFP	W	20	1	TBD	Call TI	Level-NC-NC-NC

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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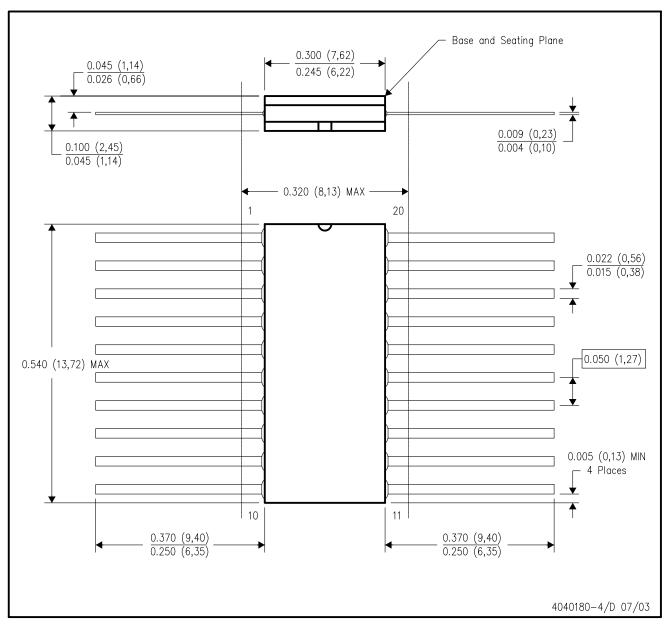
# 14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

# W (R-GDFP-F20)

# CERAMIC DUAL FLATPACK



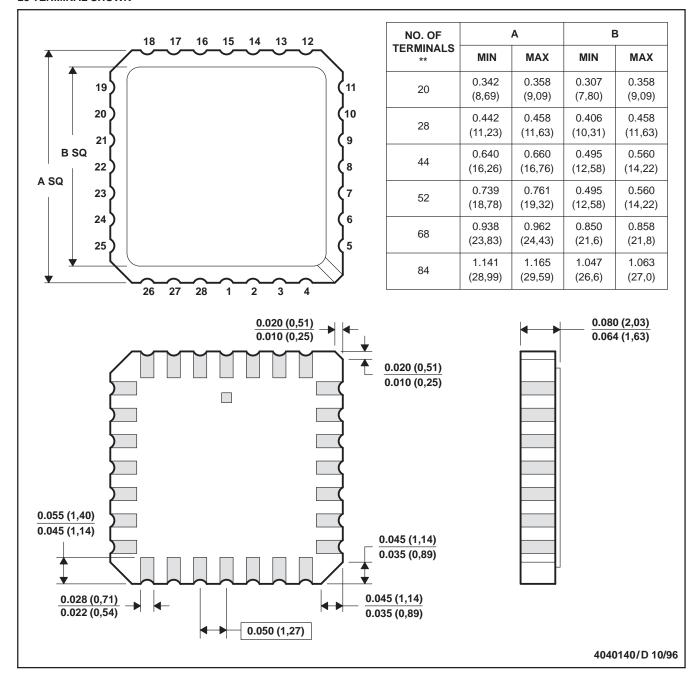
- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within Mil-Std 1835 GDFP2-F20



#### FK (S-CQCC-N\*\*)

#### **28 TERMINAL SHOWN**

#### **LEADLESS CERAMIC CHIP CARRIER**



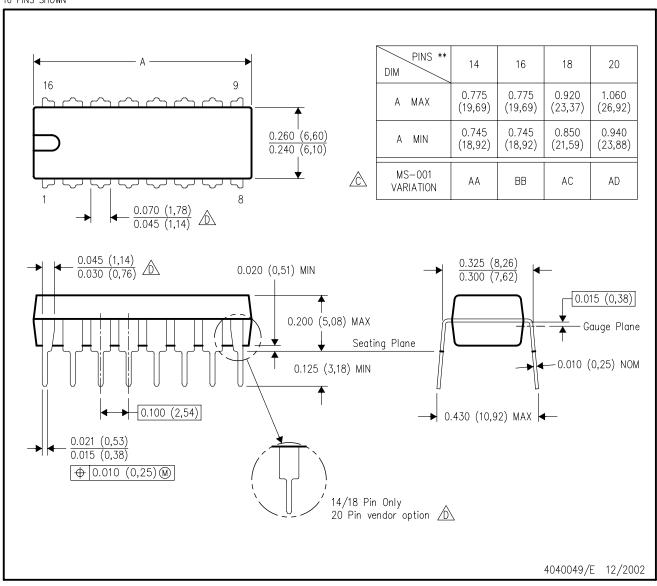
- NOTES: A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a metal lid.
  - D. The terminals are gold plated.
  - E. Falls within JEDEC MS-004



# N (R-PDIP-T\*\*)

# PLASTIC DUAL-IN-LINE PACKAGE

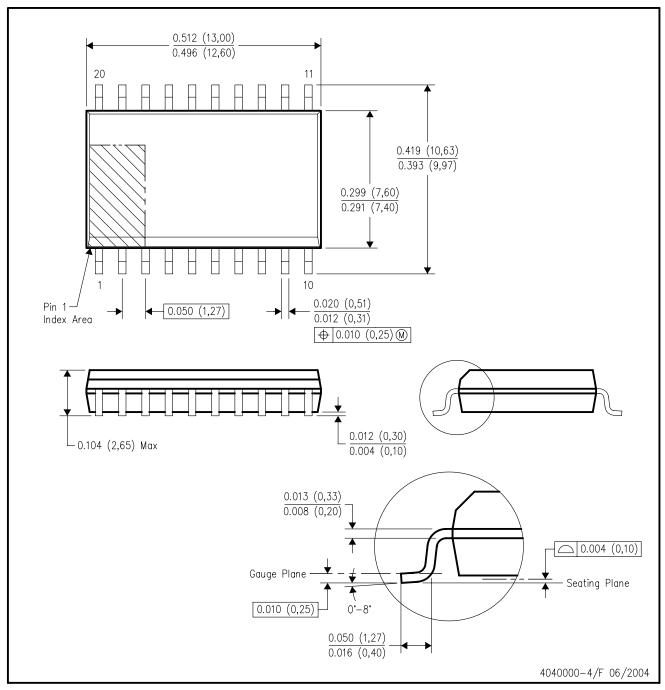
16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.

# DW (R-PDSO-G20)

# PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AC.



## **MECHANICAL DATA**

# NS (R-PDSO-G\*\*)

#### 14-PINS SHOWN

## PLASTIC SMALL-OUTLINE PACKAGE



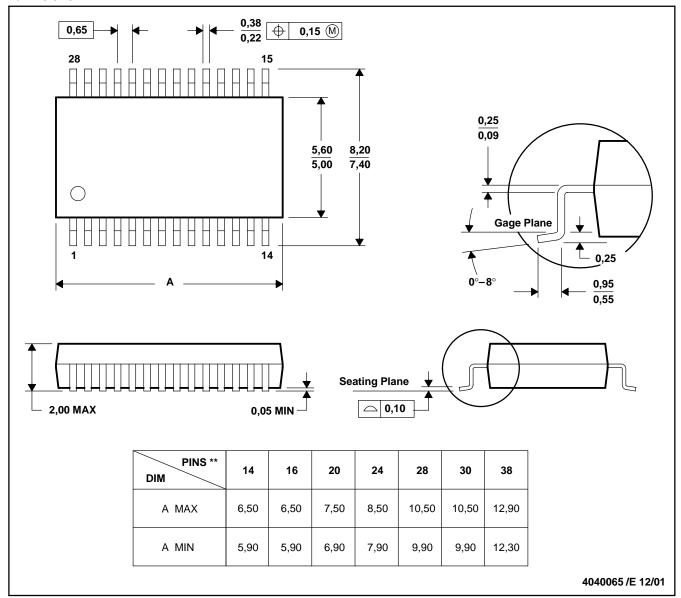
- . All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



## DB (R-PDSO-G\*\*)

#### **PLASTIC SMALL-OUTLINE**

#### **28 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-150



## PW (R-PDSO-G\*\*)

#### 14 PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153

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